

**CERTIFICATE OF ELECTRONIC  
TRANSMISSION**

I hereby certify that this correspondence for Application No. 10/524,525 is being electronically transmitted to Technology Center 1765, via EFS-WEB, on January 28, 2008.

<u>/David H. Brinkman/</u>	1/28/08
David H. Brinkman, Reg. No. 40,532	Date

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Martin Hausner
Serial No.:	10/524,525
Filed:	August 18, 2005
Confirmation No.:	1134
Group Art Unit:	1792
Examiner:	Ahmed, Shamim
Title:	<b>METHOD FOR SELECTIVELY REMOVING MATERIAL FROM THE SURFACE OF A SUBSTRATE, MASKING MATERIAL FOR A WAFER, AND WAFER WITH MASKING MATERIAL</b>
Atty. Docket:	BEET-09

Cincinnati, Ohio 45202

January 28, 2008

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**SUPPLEMENTAL AFTER FINAL AMENDMENT**

In response to the Final Office Action mailed on September 26, 2007, and supplementing the After Final Response filed on December 26, 2007, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 11 of this paper.